



**FEATURES**

- Wide Temperature Rating
- 2 Lead TO-39 Package
- Ideal for Hi Temp Industrial Applications
- Isolated Case
- RoHS and REACH Compliant

**Electro-Optical Characteristics at 25°C**

Parameters	Test Conditions	Min	Typ	Max	Units
Total Power Output, P <sub>o</sub>	I <sub>F</sub> = 500 mA	60	120		mW
Peak Emission Wavelength, λ <sub>P</sub>	I <sub>F</sub> = 50 mA		880		nm
Spectral Bandwidth at 50%, Δλ	I <sub>F</sub> = 50 mA		55		nm
Half Intensity Beam Angle, θ	I <sub>F</sub> = 50 mA		110		Deg
Forward Voltage, V <sub>F</sub>	I <sub>F</sub> = 500 mA		1.75	2	Volts
Reverse Breakdown Voltage, V <sub>R</sub>	I <sub>R</sub> = 10 μA	5	30		Volts
Capacitance, C	V <sub>R</sub> = 0 V				pF
Rise Time			20		nsec
Fall Time			20		nsec

**Absolute Maximum Ratings at 25°C Case**

Parameters	Units
Power Dissipation <sup>1</sup>	1000 mW
Continuous Forward Current	500 mA
Peak Forward Current (10 μs, 200 Hz) <sup>2</sup>	1.5 A
Reverse Voltage	5 V
Lead Soldering Temperature (1/16" from case for 10 sec)	260°C

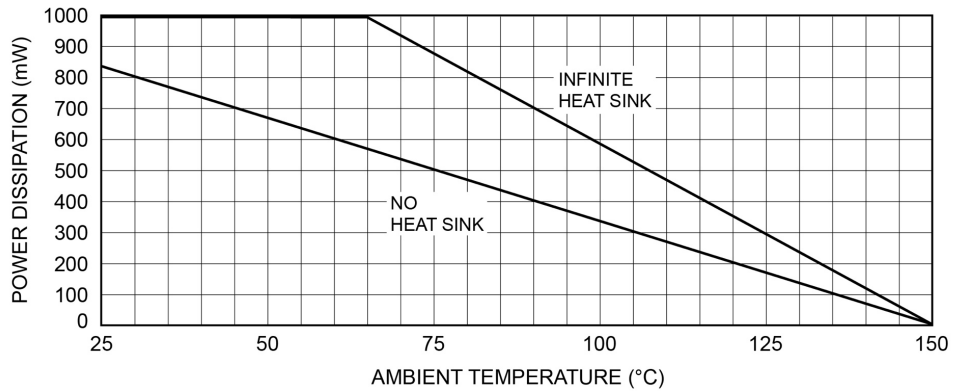
<sup>1</sup> Derate per thermal derating curve above 25°C.

<sup>2</sup> Derate linearly above 25°C.

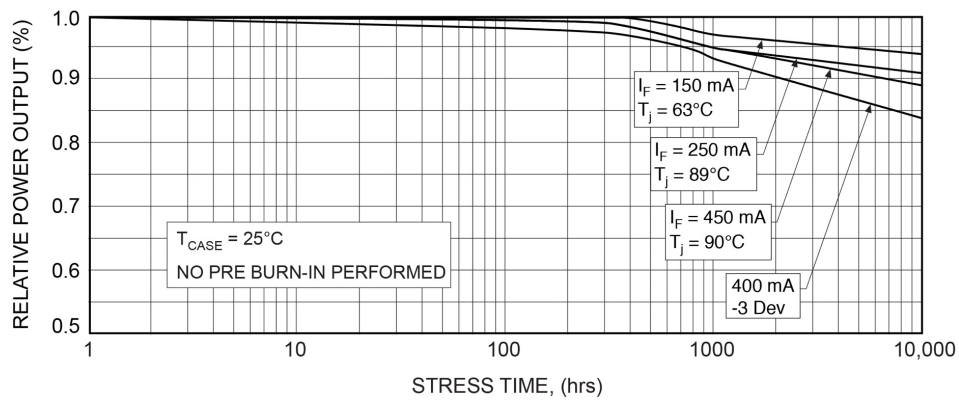
**Thermal Parameters**

Parameters	Units
Storage and Operating Temperature Range	-65°C to 150°C
Maximum Junction Temperature	150°C
Thermal Resistance, R <sub>THJA</sub>	150°C/W Typical
Thermal Resistance, R <sub>THJC</sub>	60°C/W Typical

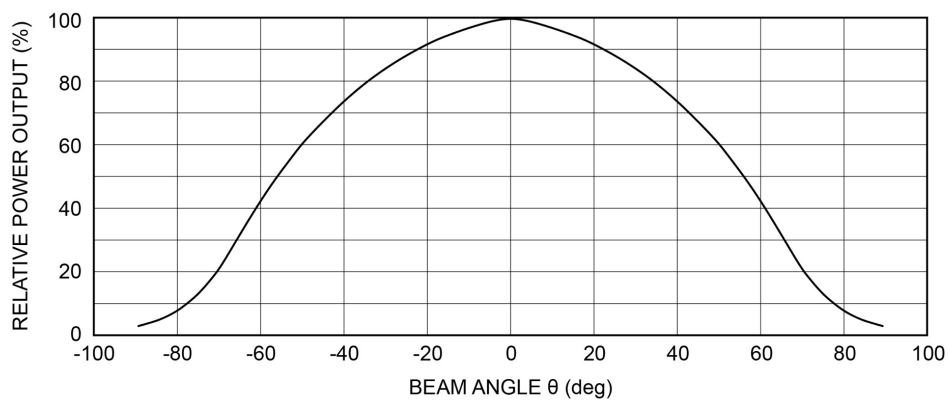
**Maximum Rated Thermal Derating Curve**



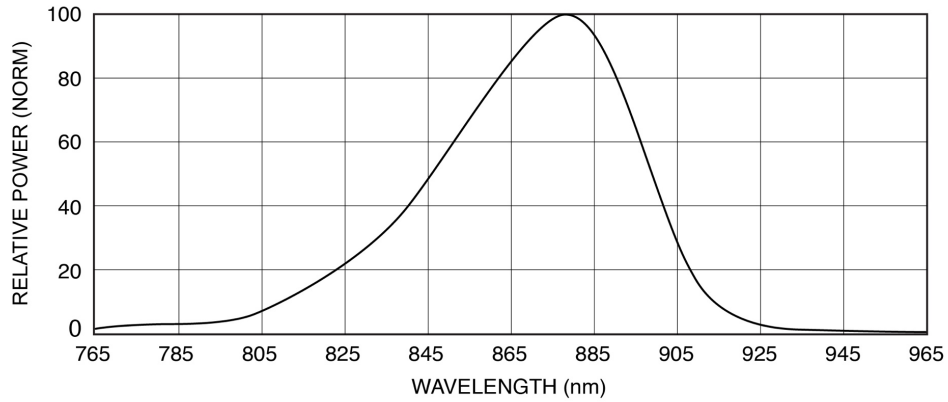
**Typical Degradation Curve**



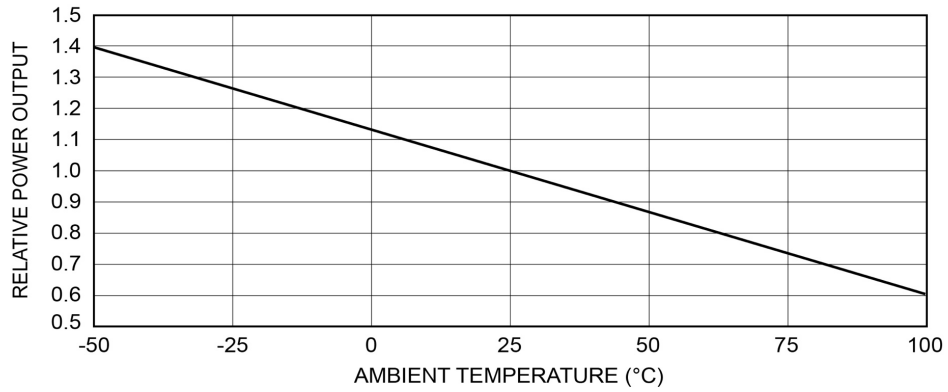
**Typical Radiation Pattern**



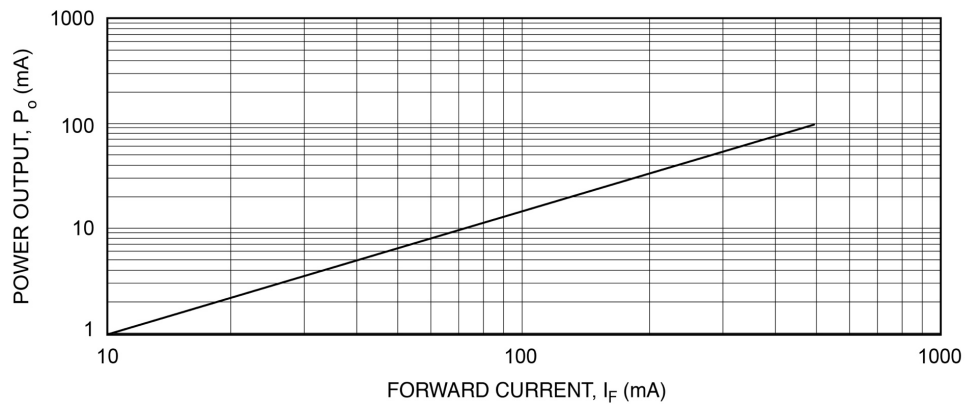
**Typical Spectral Output (50 mA, Typical)**



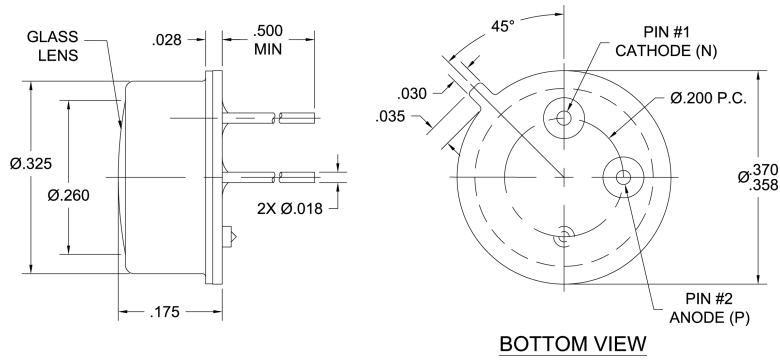
**Typical Power Output vs Temperature**



**Typical Power Output vs Forward Current**



**Package Information**



Specifications are subject to change without prior notice.